Surface Mount

Monolithic Amplifier

DC-3 GHz

Product Features

- DC-3 GHz
- Single Voltage Supply
- Internally Matched to 50 Ohm
- Unconditionally Stable
- Low Performance Variation Over Temperature
- Transient Protected
- Aqueous washable
- Protected By US Patent 6,943,629

Typical Applications

- Cellular/ PCS/ 3G Base Station
- CATV, Cable Modem & DBS
- Fixed Wireless & WLAN
- Microwave Radio & Test Equipment



CASE STYLE: WW107 PRICE: \$1.77 ea. QTY. (30)

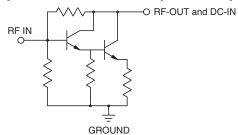
+ RoHS compliant in accordance with EU Directive (2002/95/EC)

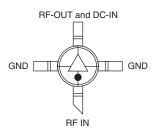
The +Suffix has been added in order to identify RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications.

General Description

ERA-33SM+ (RoHS compliant) is a wideband amplifier offering high dynamic range. It has repeatable performance from lot to lot. It is enclosed in an Micro-X package. ERA-33SM+ uses Darlington configuration and is fabricated using InGaP HBT technology. Expected MTBF is 5,250 years at 85°C case temperature.

simplified schematic and pin description

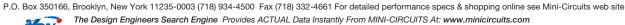




Function	Pin Number	Description
RF IN	1	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
RF-OUT and DC-IN	3	RF output and bias pin. DC voltage is present on this pin; therefore a DC blocking capacitor is necessary for proper operation. An RF choke is needed to feed DC bias without loss of RF signal due to the bias connection, as shown in "Recommended Application Circuit".
GND	2,4	Connections to ground. Use via holes as shown in "Suggested Layout for PCB Design" to reduce ground path inductance for best performance.







Electrical Specifications at 25°C and 40mA, unless noted

Parameter		Min.	Тур.	Max.	Units	Cpk
Frequency Range*		DC		3	GHz	
Gain	f=0.1 GHz	18.7	19.3	20.6	dB	≥ 1.5
	f=1 GHz		18.7			
	f=2 GHz	15	17.4	18.5		
	f=3 GHz	14.8	15.9	17		
Magnitude of Gain Variation versus Temperature	f=0.1 GHz		0.0021	.004	dB/°C	
(values are negative)	f=1 GHz		0.0029	.005		
	f=2 GHz		0.0035	.007		
	f=3 GHz		0.004	.008		
Input Return Loss	f=0.1 GHz		35		dB	
'	f=1 GHz		25			
	f=2 GHz		26			
	f=3 GHz		28			
Output Return Loss	f=0.1 GHz		35		dB	
•	f=1 GHz		22			
	f=2 GHz		20			
	f=3 GHz		20			
Reverse Isolation	f=1.0 GHz	19	22.5		dB	
Output Power @ 1 dB compression	f=0.1 GHz		14.3		dBm	≥ 1.33
	f=1 GHz		16.6			
	f=2 GHz	11.5	13.5			
	f=3 GHz		13.9			
Saturated Output Power	f=0.1 GHz		15.5		dBm	
(at 3dB compression)	f=1 GHz		15.5			
	f=2 GHz		15			
	f=3 GHz		15			
Output IP3	f=0.1 GHz	27	29.5		dBm	≥ 1.33
	f=1 GHz		30			
	f=2 GHz	27.5	30.3			
	f=3 GHz	27	30			
Noise Figure	f=0.1 GHz		3.2	4.0	dB	≥ 1.33
-	f=1GHz		3.3	4.0		
	f=2 GHz		3.3	4.1		
	f=3 GHz		3.4	4.2		
Group Delay	f=2 GHz		82		psec	
Recommended Device Operating Current			40		mA	
Device Operating Voltage		3.9	4.3	4.6	V	≥ 1.5
Device Voltage Variation vs. Temperature at 40mA			-2.9		mV/°C	
Device Voltage Variation vs. Current at 25°C			3.8		mV/mA	
Thermal Resistance, junction-to-case ¹			140		°C/W	

^{*}Guaranteed specification DC-3 GHz. Low frequency cut off determined by external coupling capacitors.

Absolute Maximum Ratings

3			
Parameter	Ratings		
Operating Temperature*	-45°C to 85°C		
Storage Temperature	-65°C to 150°C		
Operating Current	75 mA		
Power Dissipation	330 mW		
Input Power	13 dBm		

Note: Permanent damage may occur if any of these limits are exceeded. These ratings are not intended for continuous normal operation.
¹Case is defined as ground leads.

*Based on typical case temperature rise 5°C above ambient.





Product Marking



Additional Detailed Technical Information

Additional information is available on our web site. To access this information enter the model number on our web site home page.

Performance data, graphs, s-parameter data set (.zip file)

Case Style: WW107

Plastic micro-x, .085 body diameter, lead finish: tin/silver/nickel

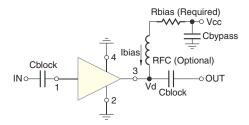
Tape & Reel: F4

Suggested Layout for PCB Design: PL-075

Evaluation Board: TB-408-33+

Environmental Ratings: ENV08T2

Recommended Application Circuit



Test Board includes case, connectors, and components (in bold) soldered to PCB

R BIAS				
Vcc	"1%" Res. Values (ohms) for Optimum Biasing			
7	69.8			
8	93.1			
9	115			
10	140			
11	165			
12	191			
13	215			
14	243			
15	267			
16	287			
17	316			
18	340			
19	365			
20	392			





ESD Rating

Human Body Model (HBM): Class 1B (500 v to < 1000 v) in accordance with ANSI/ESD STM 5.1 - 2001

Machine Model (MM): Class M1 (< 100 v) in accordance with ANSI/ESD STM 5.2 - 1999

MSL Rating

Moisture Sensitivity: MSL1 in accordance with IPC/JEDECJ-STD-020C

No.	Test Required	Condition	Standard	Quantity
1	Visual Inspection	Low Power Microscope Magnification 40x	MIP-IN-0003 (MCT spec)	45 units
2	Electrical Test	Room Temperature	SCD (MCL spec)	45 units
3	SAM Analysis	Less than 10% growth in term of delamination	J-Std-020C (Jedec Standard)	45 units
4	Moisture Sensitivity Level 1	Bake at 125°C for 24 hours Soak at 85°C/85%RH for 168 hours Reflow 3 cycles at 260°C peak	J-Std-020C (Jedec Standard)	45 units

MSL Test Flow Chart

